

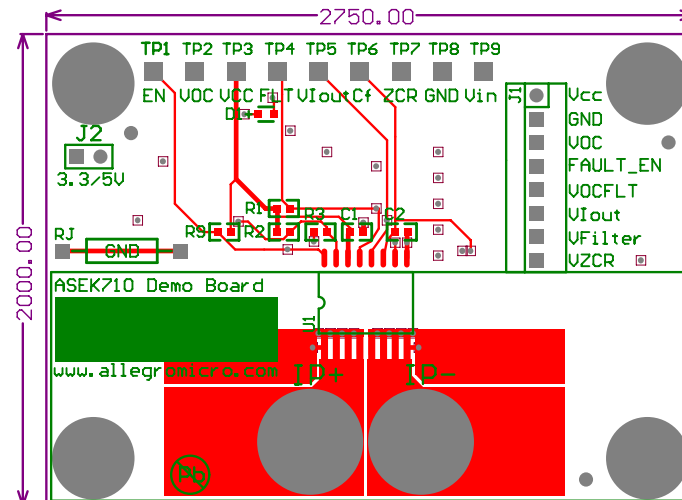
1. Finished PCB is RoHS
2. Laminate: FR4, 0.062 inch thick
 - 2a. Td min = 350C, CTE max = 3.5%
3. Layer count: 4
4. Copper Thickness: 2oz outer, 1oz inner
5. Min Trace Width = 10mil, Min Trace Separation = 10mil
 - 5a. Silkscreen: 8mil trace width
6. Finish: immersion gold
7. Top/bottom soldermask. Color = Green
8. Top/bottom silkscreen. Color = White
9. Dimensions are in inches
10. V-score separation ok
11. No Blind/Buried Vias
12. Contact information:
 Shawn Upton, suption@allegromicro.com, 603-626-2429

Layer Stackup:



□	33	15mil	0.381mm	PTH
✱	2	32mil	0.8128mm	PTH
○	10	42mil	1.0668mm	PTH
⊗	9	62mil	1.5748mm	PTH
▽	4	125mil	3.175mm	PTH
⊠	2	266mil	6.7564mm	PTH
	60	Total		

SCALE: 1.23



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